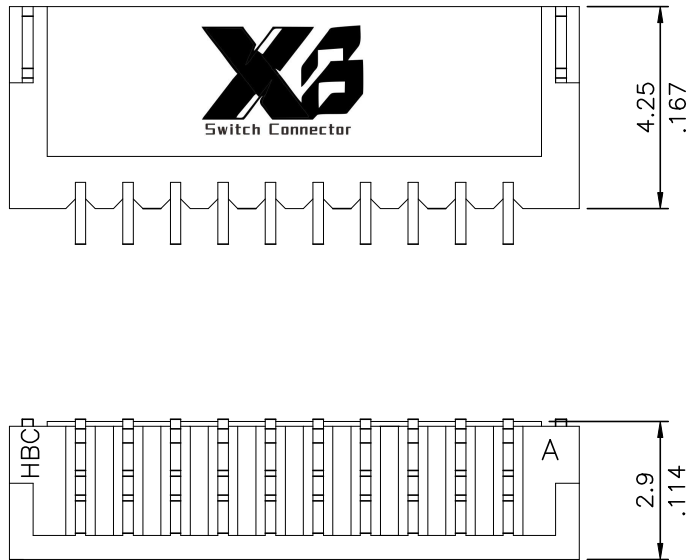
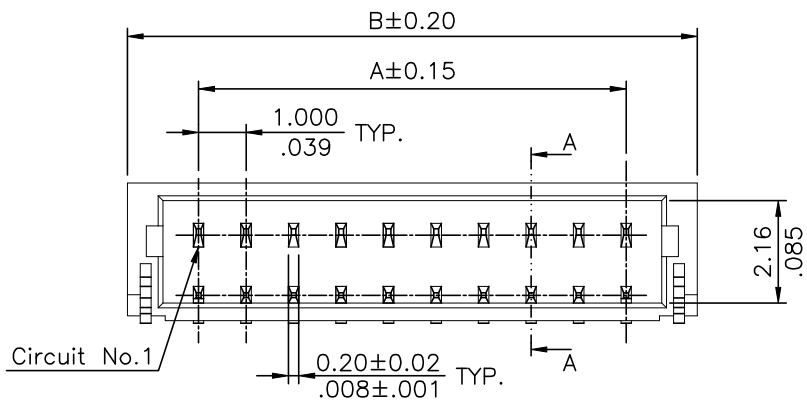


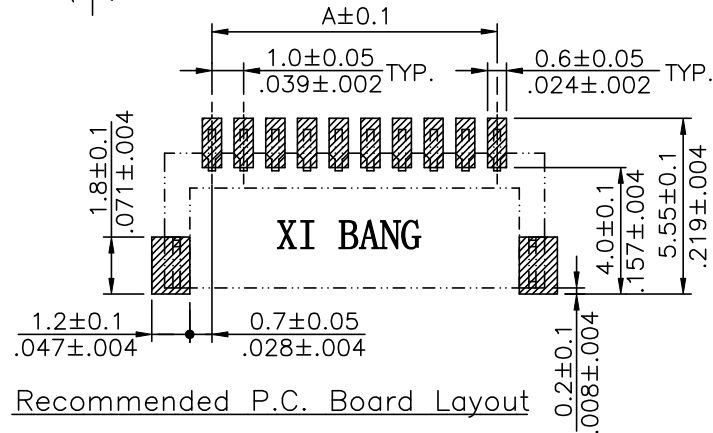
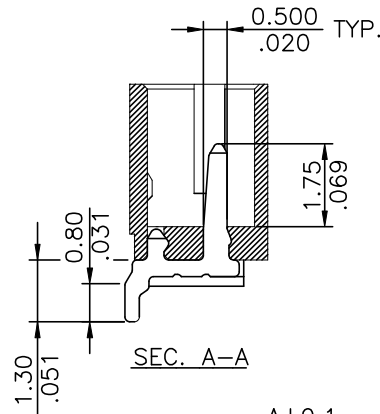
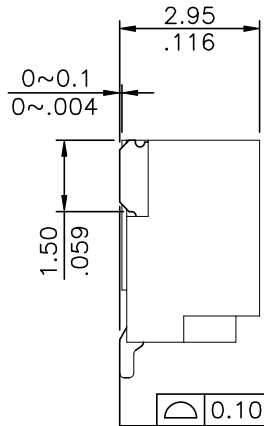


DIM. A = 1.00 x NO. OF SPACES
DIM. B = DIM. A + 3.0

△ * AVAILABLE IN 2 THROUGH 18,20,24 AND 26 CIRCUITS

NOTE:

- Material:
Base: Nylon 6T + 30% G.F UL 94V-0
Color Nature
Contact: Phosphor Bronze
Tab: Brass, with Matte Tin plated
- For Lead Free IR Reflow Process



Recommended P.C. Board Layout

ORDERING CODE

CI11 ** M * H *0 -NH
① ② ③ ④ ⑤ ⑥ ⑦

- Series No.
- Contacts:
- M= SMT type header
- Plating:
1= Matte Tin Plating over Nickel
2= Gold Flash Plating over Nickel
- Type: H= Right angle
- Option: R0= Tape & reel packing
(Without pick & place pad)
(Standard)
△ T0= Tube packing
(Without pick & place pad)
- Other option:
-NH= For Lead Free IR Processes and Halogen-Free

Lead Free Process

Halogen-Free

RoHS Compliant

△7	Amy	11/22-23	ECNT123179/ECRB123029			DATE	UNIT: mm / inch	TITLE: 1.00MM(.079")	东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.
△6	Sun	11/27-19	ECNT119339	DRAWN BY:	Amy	11/22-23'	TOLERANCE UNLESS OTHERWISE SPECIFIED	WIRE TO BOARD CONNECTOR	
△6	Ellie	12/19-14	ECNT114252/ECRT114090	ENGINEER:	Sun	11/22-23'		MATERIAL:	DRAWING NO. CI1131SI
△5	Sun	1/28-14	ECNT114016	CHECKED BY:	Eisley	11/22-23'	.X ± 0.30/.012 X' ± 1"	FINISH:	PART NO. CI11**M*H*0-NH
SYM	NAME	DATE	REVISIONS	APPROVED BY:	Eisley	11/22-23'	.XX ± 0.20/.008 X" ±		SCALE 6 / 1
							.XXX ± 0.10/.004 .XX' ±		SHEET 1 OF 2

